Absolute Maximum Rating (Ta = 25°C)

	(Characteristics	Symbol	Rating	Unit	
	Forward curr	ent		lF	50	mA
LED	Forward curr	ent derating (Ta ≥ 25°C)	ΔI _F /°C	-0.5	mA/°C
	Peak forward	d current (10	00 μs pulse, 100 pps)	IFP	1	Α
	Reverse volt	age		VR	5	N/
	Diode power	dissipation		P _D	50	mW
	Diode power	dissipation d	erating (Ta ≥ 25°C)	ΔP _D /°C	-0.5	mW/°C
	Junction tem	perature		Tj	125	°C
	Off-state out	put terminal v	oltage	Voff	350	((x/\sqrt{\sq}}\ext{\sqrt{\sq}}\sqrt{\sqrt{\sqrt{\sqrt{\sqrt{\sqrt{\sqrt{\sqrt{\sqrt{\sqrt{\sin}\sqrt{\sq}}}}}}}}}}}}}}}}}}}}}}}}}}}}}}}}}}}}
		TLP222G				
	On-state current	TLP222G-2	One channel operation	I _{ON}	120	mA
		TLI 2220-2	Two channel operations			
5	0	TLP222G				
Detector	On-state current derating (Ta ≥ 25°C)	ent	One channel operation	Δlon/°C	1.2	mA/°C
		111 2220-2	Two channel operations			~ <
	Output powe	r dissipation		Po	450	mW
	Output powe	r dissipation o	derating (Ta ≥ 25°C)	ΔP _o /°C	-4.5	mW1°C
	Junction tem	perature		Ti	125	7)°C
Storage to	emperature ra	inge	T _{stg}	−55 to 125	(°c)	
Operating	temperature	range	Topr	-40 to 85	⊸°C	
Lead sold	lering tempera	ature (10 s)	T _{sol}	260	°C	
Isolation v	voltage (AC, 6	60 s, R.H. ≤ 60	BVS	2500	Vrms	

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note 1: Device considered a two-terminal device: LED side pins shorted together and detector side pins shorted together.

Recommended Operating Conditions

Characteristics	Symbol	Min	Тур.	Max	Unit
Supply voltage	√ V _{DD}	_	_	280	٧
Forward current	(IF	5	7.5	25	mA
On-state current	ION	_	_	100	mA
Operating temperature	Topr	-20	_	65	°C

Note: Recommended operating conditions are given as a design guideline to obtain expected performance of the device. Additionally, each item is an independent guideline respectively. In developing designs using this product, please confirm specified characteristics shown in this document.

Electrical Characteristics (Ta = 25°C)

Characteristics		Symbol	Test Condition	Min	Тур.	Max	Unit
	Forward voltage	VF	IF = 10 mA	1.0	1.15	1.3	V
LED	Reverse current	I _R	V _R = 5 V	_	_	10	μΑ
	Capacitance	Ст	VF = 0 V, f = 1 MHz	_	30	_	pF
Detector	Off-state current	loff	V _{OFF} = 350 V	_	_	1	μА
	Capacitance	Coff	V = 0 V, f = 1 MHz	_	30	_	pF

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Coupled Electrical Characteristics (Ta = 25°C)

Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Trigger LED current	I _{FT}	I _{ON} = 120 mA	_	1	3	mA
Return LED current	IFC	I _{OFF} = 100 μA	0.1	_	_	mA
		I _{ON} = 120 mA, I _F = 5 mA, t < 1 s	\ -	25	35	
On-state resistance	R _{ON}	I _{ON} = 120 mA, I _F = 5 mA, continuous (Note)		35	50	Ω

Note: Continuous means a state of thermally saturated.

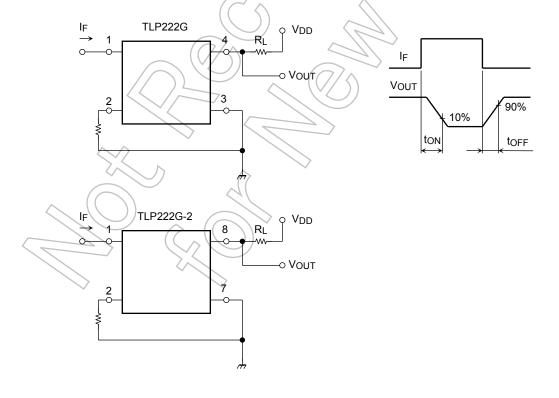
Isolation Characteristics (Ta = 25°C)

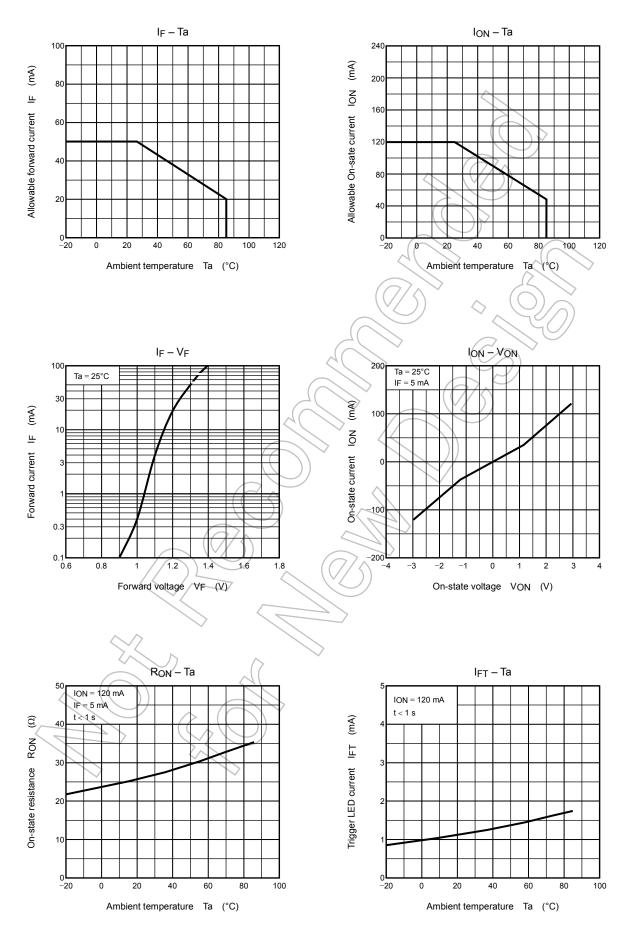
Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Capacitance input to output	Cs	V _S = 0 V, f = 1 MHz		0.8	4	pF
Isolation resistance	Rs	V _S = 500 V, R.H. ≤ 60 %	5 × 10 ¹⁰	10 ¹⁴		Ω
Isolation voltage	BVs	AC, 60 s	2500		_	Vrms

Switching Characteristics (Ta = 25°C)

Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Turn-on time	ton	R _L = 200 Ω	_	0.3	1	ms
Turn-off time	toff	$V_{DD} = 20 \text{ V, I}_F = 5 \text{ mA}$ (Note)	_	0.1	1	1113

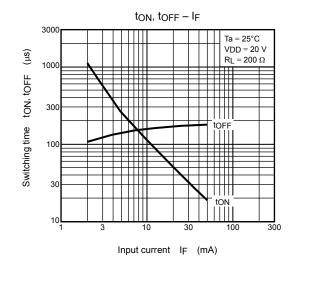
Note: Switching time test circuit

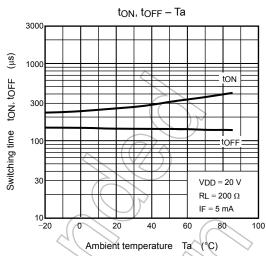


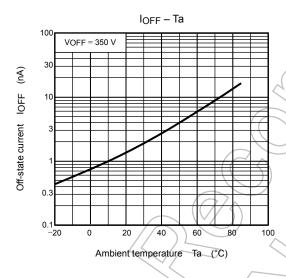


NOTE: The above characteristics curves are presented for reference only and not guaranteed by production test, unless otherwise noted.

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